

Form Type	Distribute	Version	2.0	Ref	IPC 1	752A	Sectionals	s N	Material Info	Subsection	onals D, A
				s	upplier Inform	ation					
Company Name	TE Connectivi	Request Document	ID		Contact Name	Benfe	David W	Conta		roduct Comp ND	liance Engineer for
Company Unique ID	TE Connectivi	Response	Date 2018-0	3-26	Contact Emai	dave.b	enfer@te.co	om			
Contact Phone	Number	717-986-37	25								
					Legal Stateme	ent					
Supplier Acceptance	true										
Legal Statemen	t										
The information property way modify exist	provided in this on the purchase spe	ocument is base ecifications or ex	ed upon reasor isting contract	nable inqui ual or othe	ry of our supplier agreements te	rs. This in	formation is en TE Conn	subject nectivity	t to change. The contract of the change of the contract of the	his information	on does not in any s) and its customers.
	1				Product						
Manufacturer Item number	1909784-1	Amount	5.3		Version	-	Identity		ty		
Manufacturer Item Name	WIRE TO BOARD TERMINAL 1.2MM TOP ENTRY	ARD RMINAL MM TOP			Mfr Site			Authority			
Date		UOM	Each								
EURoHS-0508	Product(s) me	Product(s) meets EU RoHS requirement without any exemptions									
ChinaRoHS- 0508	Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products										
EUREACH-0117	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH										
Complex Article Description	REACH Candi	date Substance	s of Very High				e Always an	n Article	are Not Yet F	Reviewed	
			T		Product Disclo		T	- 1-		T	<u> </u>
Sub- Item/Material/ Substance	Level	Name	Substance Category	Subst		tance entration	Quantity		Mass per Unit	UOM	Exemption
Material	1					Cittation					Liveription
		Contact - Au Plating					1.0	3	3.0E-4	mg	Exemption
Substance	2		Supplier	7440-5	57-5 99.92		1.0		3.0E-4 2.9976E-4	mg mg	Liemphon
Substance Substance	2	Plating	Supplier Supplier	7440-5 TE508 0909				2		+	Literaphon
		Gold Contains No Reportable TE5081-2	1 ''	TE508			1.0	1	2.9976E-4	mg	Literaphon
Substance	2	Plating Gold Contains No Reportable TE5081-2 Substances	1 ''	TE508	1-2- 0.08		1.0	1	2.9976E-4 1.0E-5	mg mg	Lagripuon
Substance Material	2	Plating Gold Contains No Reportable TE5081-2 Substances Contact	Supplier	TE508 0909	0.08		1.0	1 5	2.9976E-4 1.0E-5 5.2457	mg mg	Lagripuon
Substance Material Substance Substance	2 1 2	Plating Gold Contains No Reportable TE5081-2 Substances Contact Copper	Supplier Supplier	TE508 0909 7440-5	0.08 0.08 0.08 0.08 0.09 0.09		1.0 1.0 1.0	5	2.9976E-4 1.0E-5 5.2457 4.72113	mg mg mg mg	Lagripuon
Substance Material Substance Substance	2 1 2 2	Plating Gold Contains No Reportable TE5081-2 Substances Contact Copper Zinc	Supplier Supplier Supplier	TE508 0909 7440-5 7440-6	11-2- 0.08 50-8 90.0 56-6 0.2 39-6 0.1		1.0 1.0 1.0 1.0 1.0	2 1 5 4 0	2.9976E-4 1.0E-5 5.2457 1.72113 0.0104914	mg mg mg mg mg	LAGINPHON
Material Substance Substance Substance Substance	2 1 2 2 2	Plating Gold Contains No Reportable TE5081-2 Substances Contact Copper Zinc Iron	Supplier Supplier Supplier Supplier	7440-5 7439-8	11-2- 0.08 50-8 90.0 56-6 0.2 39-6 0.1 31-5 9.3		1.0 1.0 1.0 1.0 1.0 1.0	2 1 5 4 0 0	2.9976E-4 1.0E-5 5.2457 1.72113 0.0104914 0.0052457	mg mg mg mg mg	LAGINPHON
Material Substance Substance Substance Substance Substance Substance Substance	2 1 2 2 2 2	Plating Gold Contains No Reportable TE5081-2 Substances Contact Copper Zinc Iron	Supplier Supplier Supplier Supplier Supplier Supplier	7440-5 7439-8 7440-3	50-8 90.0 56-6 0.2 39-6 0.1 31-5 9.3 14-0 0.35		1.0 1.0 1.0 1.0 1.0 1.0 1.0	5 5 0 0	2.9976E-4 1.0E-5 5.2457 1.72113 0.0104914 0.0052457 0.48785	mg mg mg mg mg mg	LAGINPHON
Material Substance Substance Substance Substance Substance Substance Substance	1 2 2 2 2 2 2	Plating Gold Contains No Reportable TE5081-2 Substances Contact Copper Zinc Iron Tin Phosphorus	Supplier Supplier Supplier Supplier Supplier Supplier Supplier Lead/Lead	7440-5 7440-6 7439-8 7440-3 7723-1	50-8 90.0 56-6 0.2 39-6 0.1 31-5 9.3 14-0 0.35		1.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0	2 5 5 4 4 C C C C C C C C C C C C C C C C	2.9976E-4 1.0E-5 5.2457 4.72113 0.0104914 0.0052457 0.48785 0.01835995	mg mg mg mg mg mg mg mg mg	LAGINPHON
Material Substance Substance Substance Substance Substance Substance Substance Material	1 2 2 2 2 2 2 2 2	Plating Gold Contains No Reportable TE5081-2 Substances Contact Copper Zinc Iron Tin Phosphorus Lead Contact -	Supplier Supplier Supplier Supplier Supplier Supplier Supplier Lead/Lead	7440-5 7440-6 7439-8 7440-3 7723-1	11-2- 0.08 50-8 90.0 56-6 0.2 39-6 0.1 31-5 9.3 14-0 0.35 32-1 0.05		1.0 1.0 1.0 1.0 1.0 1.0 1.0 1.0	2 1 1 1	2.9976E-4 1.0E-5 5.2457 4.72113 0.0104914 0.0052457 0.48785 0.01835995 0.00262285	mg	